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formed, provided on the base film side adhesive layer; and a cover layer side adhesive layer provided on the metal foil layer,

wherein at least one of the base film side adhesive layer and the cover layer side adhesive layer has a higher glass transition temperature than an operating temperature of the flexible printed circuit board.

5. (Amended) A flexible printed circuit board according to claim 1, wherein a reciprocation number N indicating a bending life of the flexible printed circuit board is ten million times or greater at 60°C.

6. (Amended) A flexible printed circuit board according to claim 1, wherein a reciprocation number N indicating a bending life of the flexible printed circuit board is between a million times and ten million times at 80°C.

REMARKS

The Office Action was issued on pending claims 1-6, all of which were rejected. Claims 1, 5, and 6 have been amended, and no claims have been added or cancelled. Thus, claims 1-6 are pending in the case.

On page 2 of the Office Action, the drawings were objected to under the assertions that (1) the reference numerals are not mentioned in pages 4-8 of the written description, (2) Fig. 1 should be designated by a legend such as "Prior Art," and (3) Fig. 1 shows modified forms of construction in the same view.

Regarding the reference numerals, the enclosed substitute specification includes reference numerals in the Detailed Description of the Invention which correspond to the Figures.

Regarding the legend of Fig. 1, Applicants request Fig. 1 be amended to include the legend "Conventional Art." A copy of Fig. 1 with the requested amendment marked in red ink is enclosed.